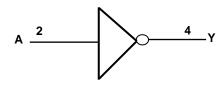


# **Pin Descriptions**

Pin Name	Pin No	Description		
NC	1	No Connection		
Α	2	Data Input		
GND	3	Ground		
Y	4	Data Output		
V <sub>CC</sub>	5	Supply Voltage		

# Logic Diagram



# **Function Table**

Inputs	Output
Α	Υ
Н	L
L	Н

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# **Absolute Maximum Ratings (Note 2)**

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	K۷
ESD MM	Machine Model ESD Protection	200	V
V <sub>CC</sub>	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.5 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	Input Clamp Current V <sub>I</sub> <0	-20	mA
l <sub>OK</sub>	Output Clamp Current (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±20	mA
I <sub>O</sub>	Continuous output current (V <sub>O</sub> = 0 to V <sub>CC</sub> )	±25	mA
I <sub>CC</sub>	Continuous current through V <sub>CC</sub>	50	mA
I <sub>GND</sub>	Continuous current through GND	-50	mA
TJ	Operating Junction Temperature	-40 to 150	°C
T <sub>STG</sub>	Storage Temperature	-65 to 150	°C

Notes: 2. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

# **Recommended Operating Conditions (Note 3)**

Symbol		Parameter	Min	Max	Unit
V <sub>CC</sub>	Operating Voltage		4.5	5.5	V
$V_{IH}$	High-level Input Voltage		2.0		V
V <sub>IL</sub>	Low-level input voltage			0.8	V
VI	Input Voltage		0	5.5	V
Vo	Output Voltage		0	$V_{CC}$	<b>V</b>
I <sub>OH</sub>	High-level output current			-8	mA
I <sub>OL</sub>	Low-level output current			8	mA
Δt/ΔV	Input transition rise or fall rate			20	ns/V
T <sub>A</sub>	Operating free-air temperature		-40	125	°C

Notes: 3. Unused inputs should be held at  $V_{\mbox{CC}}$  or Ground.



### **Electrical Characteristics**

0	D	Test	V		25ºC		-40°C t	:o 85ºC	-40°C to	o 125ºC	1121
Symbol	Parameter	Conditions	V <sub>CC</sub>	Min	Тур.	Max	Min	Max	Min	Max	Unit
.,,	High Level	I <sub>OH</sub> = -50μA	4.5V	4.4	4.5		4.4		4.4		.,
V <sub>OH</sub>	Output Voltage	$I_{OH} = -8mA$	4.5V	3.94			3.8		3.70		V
.,	Low Level	$I_{OL} = 50\mu A$	4.5V		0	0.1		0.1		0.1	V
V <sub>OL</sub>	Output Voltage	$I_{OL} = 8mA$	4.5V			0.36		0.44		0.55	V
II	Input Current	$V_I = 5.5V$ or GND	0 to 5.5V			± 0.1		± 1		± 2	μΑ
I <sub>CC</sub>	Supply Current	$V_I = 5.5V$ or GND $I_O=0$	5.5V			1		10		40	μΑ
Ci	Input Capacitance	$V_I = V_{CC} - or$ GND	5.5V		2.0	10		10		10	pF
ΔI <sub>CC</sub>	Additional Supply Current	Input at 3.4 V	5.5V			1.35		1.5			mA
$\theta_{JA}$	Thermal Resistance	SOT25	(Note 4)		204						°C/W
ОЈД	Junction-to- Ambient	SOT353	(11016-4)		371						C/VV
	Thermal Resistance	SOT25	(Note 4)		52						°C/W
θ <sub>JC</sub>	Junction-to- Case	SOT353	(Note 4)		143						C/VV

Note: 4. Test conditions for SOT25, and SOT353: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

# **Switching Characteristics**

 $V_{CC} = 5V \pm 0.5V$  (see Figure 1)

Doromotor	From	то			25°C		-40°C t	o 85ºC	-40°C to	o 125ºC	Unit
Parameter	(Input)	(OUTPUT)		Min	Тур.	Max	Min	Max	Min	Max	Unit
4	^	V	C <sub>L</sub> =15pF	0.6	3.4	6.7	0.6	7.5	0.6	8.5	ns
<sup>Т</sup> рd	A	ľ	C <sub>L</sub> =50pF	0.6	4.9	7.7	0.6	8.5	0.6	10.05	ns

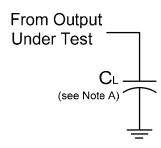
# **Operating Characteristics**

 $T_A = 25$  °C

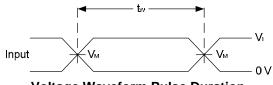
Parameter		Test Conditions	V <sub>CC</sub> = 5 V Typ.	Unit
$C_{pd}$	Power dissipation capacitance	f = 1 MHz No Load	15	pF



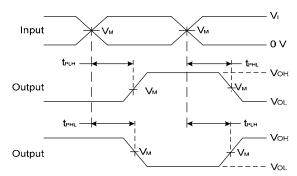
### **Parameter Measurement Information**



V	Inputs		V	C	
V <sub>CC</sub>	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	CL	
5V±0.5V	3V	≤3ns	1.5V	15pF	
5V±0.5V	3V	≤3ns	1.5V	50pF	



**Voltage Waveform Pulse Duration** 



Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Notes: A. Includes test lead and test apparatus capacitance.

B. All pulses are supplied at pulse repetition rate ≤ 1 MHz.

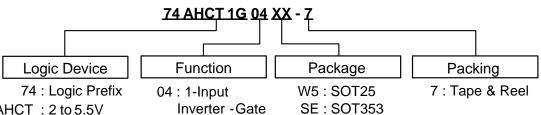
C. Inputs are measured separately one transition per measurement.

D. t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.

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# **Ordering Information**



AHCT: 2 to 5.5V

Family with TTL input level

1G: One gate

	Davisa	Package	Packaging	7" Tape and Reel		
	Device	Code	(Note 5)	Quantity	Part Number Suffix	
<b>Pb</b> ,	74AHCT1G04W5-7	W5	SOT25	3000/Tape & Reel	-7	
<b>@</b> ,	74AHCT1G04SE-7	SE	SOT353	3000/Tape & Reel	-7	

Notes: 5. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

# **Marking Information**

#### (Top View)

5 4

XX Y W X

2 3 XX: Identification code

Y: Year 0~9

<u>W</u>: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents 52 and 53 week

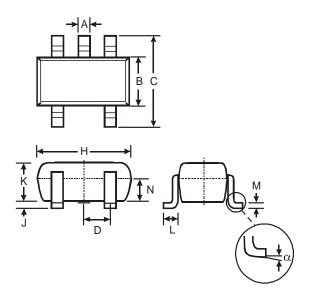
X: A~Z: Internal code

Part Number	Package	Identification Code
74AHCT1G04W5	SOT25	ZT
74AHCT1G04SE	SOT353	ZT



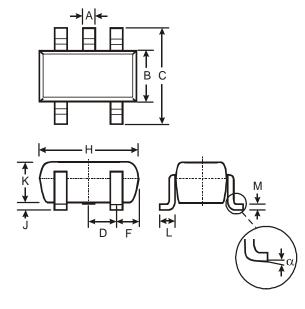
# Package Outline Dimensions (All Dimensions in mm)

# (1) Package Type: SOT25



	SOT25						
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D			0.95				
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
K	1.00	1.30	1.10				
L	0.35	0.55	0.40				
M	0.10	0.20	0.15				
N	0.70	0.80	0.75				
α	0°	8°					
All Dimensions in mm							

### (2) Package Type: SOT353



	SOT353				
Dim	Min	Max			
Α	0.10	0.30			
В	1.15	1.35			
C	2.00	2.20			
D	0.65 Typ				
F	0.40	0.45			
Η	1.80	2.20			
7	0	0.10			
K	0.90	1.00			
L	0.25	0.40			
М	0.10	0.22			
α	0°	8°			
All Dimensions in mm					



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